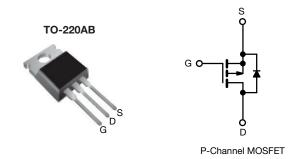
Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	-100			
$R_{DS(on)}(\Omega)$	V _{GS} = -10 V 0.30			
Q _g max. (nC)	38			
Q _{gs} (nC)	6.8			
Q _{gd} (nC)	21			
Configuration	Single			



FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- P-channel
- 175 °C operating temperature
- Fast switching
- · Ease of paralleling
- Simple drive requirements
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF9530PbF		
Lead (Fb)-free	SiHF9530-E3		
SnPb	IRF9530		
SIPO	SiHF9530		

ABSOLUTE MAXIMUM RATINGS (T _C = PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V _{DS}	-100	Oitii	
Gate-Source Voltage	V _{DS}	± 20	V	
<u> </u>	▼GS	- 12		
Continuous Drain Current	V_{GS} at - 10 V $T_{C} = 25 ^{\circ}C$ $T_{C} = 100 ^{\circ}C$	I _D	-8.2	A
Pulsed Drain Current ^a	I _{DM}	-48		
Linear Derating Factor		0.59	W/°C	
Single Pulse Avalanche Energy b	E _{AS}	400	mJ	
Repetitive Avalanche Current a	I _{AR}	-12	Α	
Repetitive Avalanche Energy ^a	E _{AR}	8.8	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$		P_{D}	88	W
Peak Diode Recovery dV/dt ^c	dV/dt	- 5.5	V/ns	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +175	00	
Soldering Recommendations (Peak temperature) ^d		300	°C	
Mounting Toyour	C 20 or M2 corour		10	lbf ⋅ in
Mounting Torque	6-32 or M3 screw		1.1	N · m

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. $V_{DD}=$ -25 V, starting $T_J=$ 25 °C, L= 4.2 mH, $R_g=$ 25 Ω , $I_{AS}=$ -12 A (see fig. 12). c. $I_{SD}\leq$ -12 A, $dI/dt\leq$ 140 A/ μ s, $V_{DD}\leq$ V_{DS} , $T_J\leq$ 175 °C.
- d. 1.6 mm from case.

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.7		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$		-100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = -1 mA	-	-0.10	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = \	/ _{GS} , I _D = -250 μA	-2.0	-	-4.0	V
Gate-Source Leakage	I _{GSS}	V	_{GS} = ± 20 V	-	-	± 100	nA
	_	V _{DS} = -	V _{DS} = -100 V, V _{GS} = 0 V		-	-100	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -80 \text{ V},$	V _{GS} = 0 V, T _J = 150 °C	-	-	-500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = -10 V	I _D = -7.2 A ^b	-	-	0.30	Ω
Forward Transconductance	g _{fs}	V _{DS} = -	50 V, I _D = -7.2 A ^b	3.7	-	-	S
Dynamic					ı		ı
Input Capacitance	C _{iss}		V 0V		860	-	
Output Capacitance	C _{oss}	V	$V_{GS} = 0 \text{ V},$ $DS = -25 \text{ V},$	-	340	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.0	MHz, see fig. 5	ı	93	-	
Total Gate Charge	Qg				-	38	
Gate-Source Charge	Q _{gs}	V _{GS} = -10 V	$I_D = -12 \text{ A}, V_{DS} = -80 \text{ V},$ see fig. 6 and 13 b	-	-	6.8	nC
Gate-Drain Charge	Q _{gd}		see fig. 6 and 135	ı	-	21	
Turn-On Delay Time	t _{d(on)}		1	ı	12	-	
Rise Time	t _r	$V_{DD} = -50 \text{ V, } I_D = -12 \text{ A,}$ $R_g = 12 \ \Omega, R_D = 3.9 \ \Omega, \text{ see fig. } 10^{\text{ b}}$		-	52	-	ns
Turn-Off Delay Time	t _{d(off)}			-	31	-	
Fall Time	t _f			-	39	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from		-	4.5	-	- nH
Internal Source Inductance	L _S	die contact	package and center of die contact		7.5	-	
Gate Input Resistance	R_g	f = 1 MHz, open drain		0.4	-	3.3	Ω
Drain-Source Body Diode Characteristic	s	_				1	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p -n junction diode		ı	-	-12	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	-48	
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = -12 A, V _{GS} = 0 V ^b		-	-	-6.3	V
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = -12 A, dl/dt = 100 A/μs b		-	120	240	ns
Body Diode Reverse Recovery Charge	Q_{rr}			-	0.46	0.92	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				y L _S and	L_D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

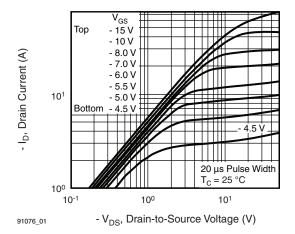


Fig. 1 -Typical Output Characteristics, T_C = 25 °C

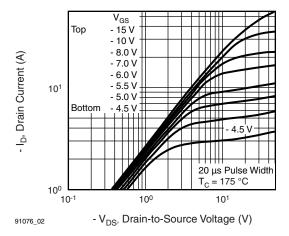


Fig. 2 - Typical Output Characteristics, $T_C = 175$ °C

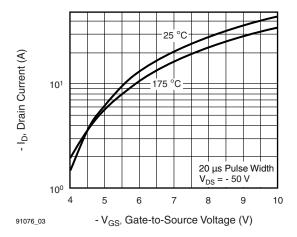


Fig. 3 - Typical Transfer Characteristics

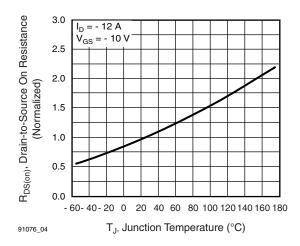


Fig. 4 -Normalized On-Resistance vs. Temperature

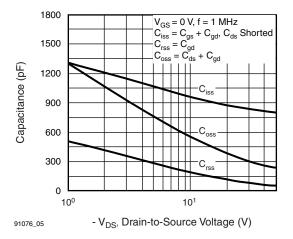


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

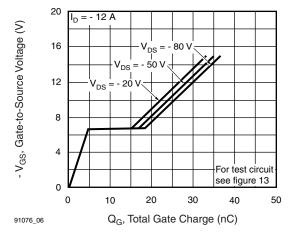


Fig. 6 -Typical Gate Charge vs. Gate-to-Source Voltage



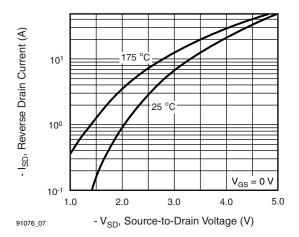


Fig. 7 - Typical Source-Drain Diode Forward Voltage

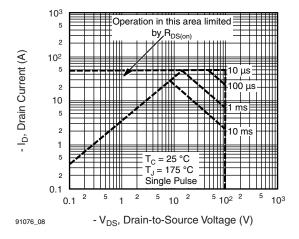


Fig. 8 - Maximum Safe Operating Area

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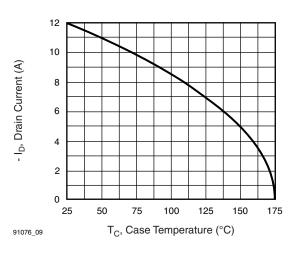


Fig. 9 - Maximum Drain Current vs. Case Temperature

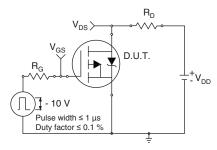


Fig. 10a - Switching Time Test Circuit

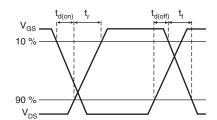


Fig. 10b - Switching Time Waveforms

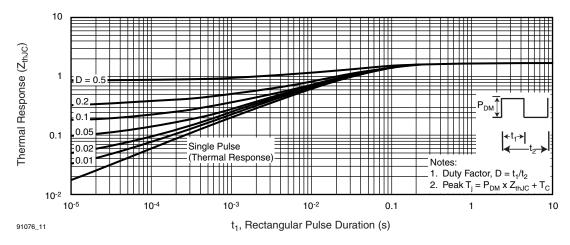


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



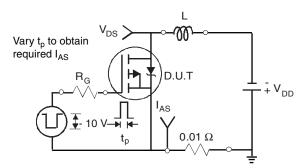


Fig. 12a - Unclamped Inductive Test Circuit

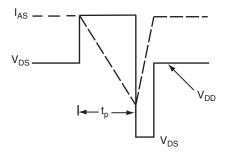


Fig. 12b - Unclamped Inductive Waveforms

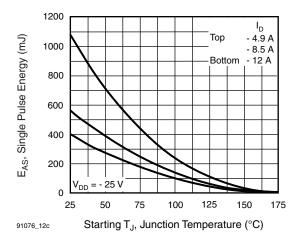


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

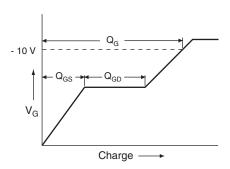


Fig. 13a - Basic Gate Charge Waveform

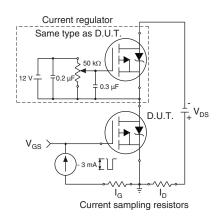
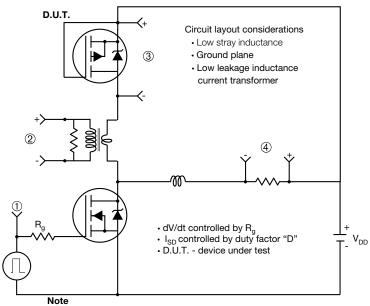


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



· Compliment N-Channel of D.U.T. for driver

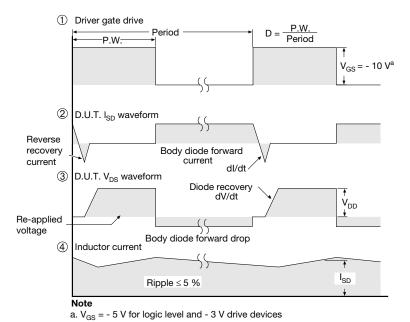
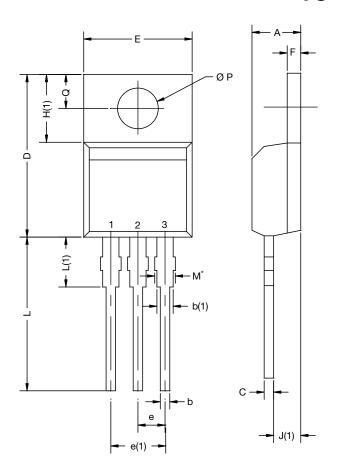


Fig. 14 -For P-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91076.



TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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